CBT-39-UV LEDs

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Features:

- Greater than 4W at 405nm
- Chip area 1:1.1 aspect ratio: matched to TI's 0.55" XGA DLP for 3D priting applications
- Low thermal resistance package, $R_{th,\ j\text{-}hs}$ = 1.8°C/W
- Centroid wavelengths: 405 nm
- RoHS and REACh compliant

Applications

- 3D Printing
- Fluorescence imaging
- Ink and adhesives curing
- Spot curing
- Machine vision
- Medical and scientific instrumentation

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Technology Overview

Luminus Big Chip LEDs™ benefit from innovations in device technology, chip packaging and thermal management. This suite of technologies give engineers and system designers the freedom to develop solutions both high in power and efficiency.

Luminus Technology

Luminus' technology enables large area LED chips to emit photons uniformly over the entire LED chip surface. The intense optical power density produced by these UV Big Chip LEDs™ facilitate designs which replace arc and halogen lamps where arrays of traditional high power LEDs cannot.

For UV devices, Luminus engineers the Big Chip LEDs™ to maximize light extraction and to emit with a Lambertian far-field distribution pattern. The design maximizes efficiency and allows for flexible optical designs.

Packaging Technology

Thermal management is critical in high power LED applications. Luminus CBT-39-UV LEDs have the lowest thermal resistance of any LED on the market with a thermal resistance from junction to heat sink of 1.8°C/W. This allows the LED to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions and longer lifetimes.

Reliability

Designed from the ground up, Luminus Big Chip LEDs are one of the most reliable light sources in the world today. Big Chip LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that typically exceed 10,000 hours, Luminus Big Chip LEDs are ready for even the most demanding applications.

Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All Big Chip LED products manufactured by Luminus are RoHS compliant and free of hazardous materials, including lead and mercury.

Understanding Big Chip LED Test Specifications

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

Testing Temperature

Luminus core board products are typically measured in such a way that the characteristics reported agree with how the devices will actually perform when incorporated into a system. This measurement is accomplished by mounting the devices on a 40°C heat sink. This method of measurement ensures that Luminus Big Chip LEDs perform in the field just as they are specified.

Operating Points

The tables on the following pages provide typical optical and electrical characteristics. The LEDs can be operated over a wide range of drive conditions(currents from <1A to 9.75 A, and duty cycle from <1% to 100%).

CBT-39-UV devices are production specified at 6 A. Any other values shown are for additional reference at other possible drive conditions.

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CBT-39-UV Binning Structure

CBT-39-UV LEDs are specified for luminous flux and chromaticity/wavelength at a drive current of 6 A (1.54 A/mm2) and placed into one of the following Power Bins and Wavelength Bins:

Power Bins

Color	Power Flux Bin (F)	Minimum Flux (W)	Maximum Flux (W)
UV	DA	4.00	4.33
	DB	4.33	4.67
	DC	4.67	5.00
	EA	5.00	5.50
	EB	5.50	6.00
	FA	6.00	6.50

*Note: Luminus maintains a +/- 6% tolerance on power measurements.

Wavelength Bins

Color	Wavelength Bin (123)	Minimum Wavelength (nm)	Maximum Wavelength (nm)
UV	400	400	405
	405	405	410

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Reference Optical & Electrical Characteristics (T_{hs} = 40°C)[1,2]

UV			
Wavelength		***405 nm***	
Parameter	**Symbol**	**Values[3]**	**Unit**
Current Density[4]	j	1.54	A/mm²
Forward Voltage	$V_{F\,min}$	3.0	V
	V_F	3.5	V
	$V_{F\,max}$	4.2	V
Radiometric Flux[5]	Φ_{typ}	5.5	Ω
Radiometric Flux Density	Φ_R	1.41	W/mm²
Wavelength Range	λ	400 - 410	nm
Centroid Wavelength	λ_p	405	nm
FWHM	$\Delta\lambda_{1/2}$	15	nm

	Symbol	**UV**	**Unit**
Emitting Area		3.9	mm²
Emitting Area Dimensions		1.87 x 2.09	mm × mm
Dynamic Resistance	Ω_{dyn}	0.02	Ω

Absolute Maximum Ratings

	Symbol	**UV**	**Unit**
Maximum Current CW[6]		6	A
Maximum Current Pulsed[6]		9.75	A
Maximum Junction Temperature[7]	T_{jmax}	150	°C
Storage Temperature Range		-40 to +100	°C

Note 1: Data verified using NIST traceable calibration standard.

Note 2: All data are based on test conditions with a constant heat sink temperature T_{hs} = 40°C under pulse testing conditions. Pulse conditions: 25% duty-cycle and frequency of 720 Hz. Nominal $T_j \approx$ 80°C. See Thermal Resistance section for T_j and T_{hs} definition.

Note 3: Unless otherwise noted, values listed are typical. Devices are production tested and specified at 6 A.

Note 4: Listed drive conditions are typical for common applications. CBT-39-UV devices can be driven at currents ranging from <1 A to 6 A and at duty cycles ranging from 1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirement.

Note 5: Typical total flux from emitting area at listed centroid wavelength. Reported performance is included to show trends for a selected power level. For specific minimum and maximum values, use bin tables. For product roadmap and future performance of devices, contact Luminus.

Note 6: CBT-39-UV LEDs are designed for operation to an absolute maximum current as specified above. Product lifetime data is specified at recommended forward drive currents. Sustained operation at or beyond absolute maximum currents will result in a reduction of device life time compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to the lifetime derating curves for further information. In pulsed operation, rise time from 10-90% of forward current should be longer than 0.5 µseconds.

Note 7: Lifetime dependent on LED junction temperature. Input power and thermal system must be properly managed to ensure lifetime.

Note 8: Special design considerations must be observed for operation under 1 A. Please contact Luminus for further information.

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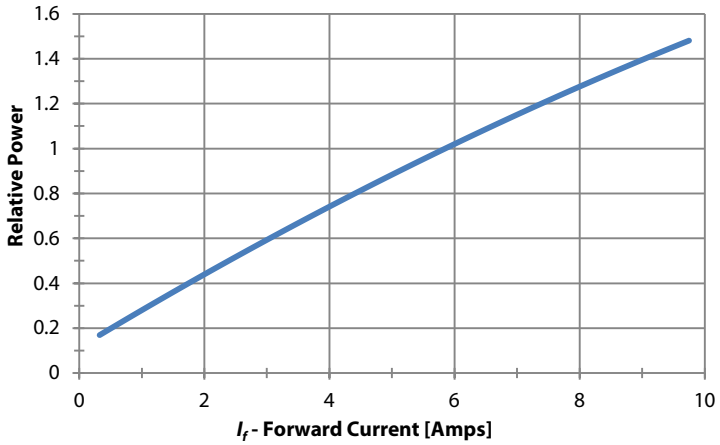
Optical & Electrical Characteristics

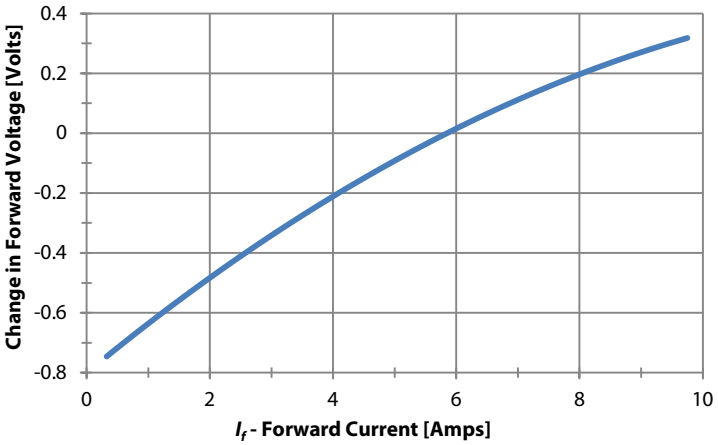
Relative Power *vs* Forward Current (I_f): Normalized to T_j = 120°C and I_f = 6 A

405 nm



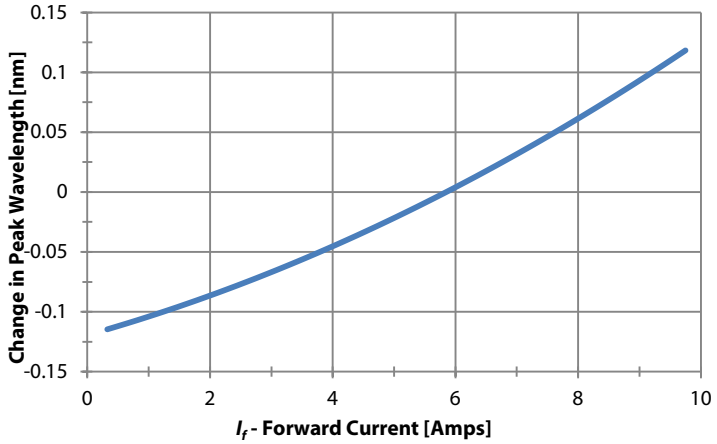
Change in Forward Voltage *vs* Forward Current (I_f): Normalized to T_j = 120°C and I_f = 6 A

405 nm



Change in Centroid Wavelength *vs* Forward Current (I_f): Normalized to T_j = 120°C and I_f = 6 A

405 nm



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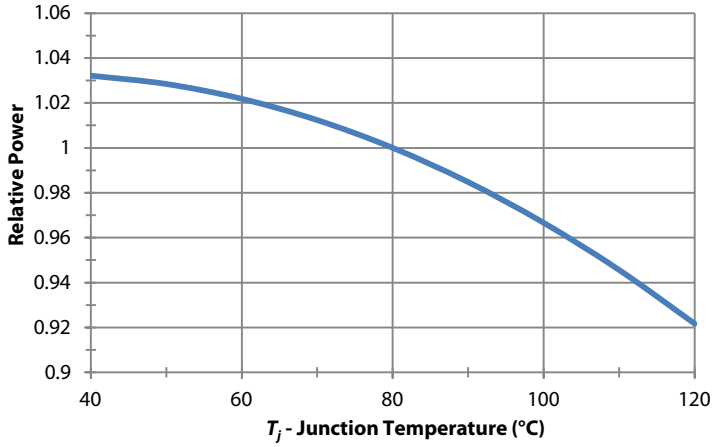
Optical and Electrical Characteristics *vs* T_j [°C]

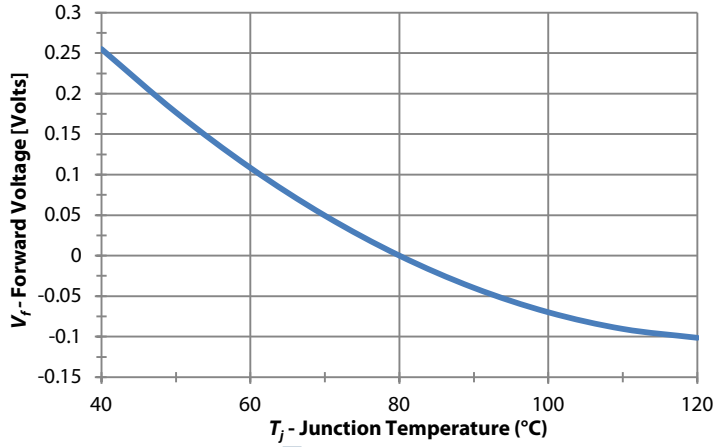
Relative Power *vs* T_j: Normalized to I_f = 6 A and T_j = 80°C

405 nm



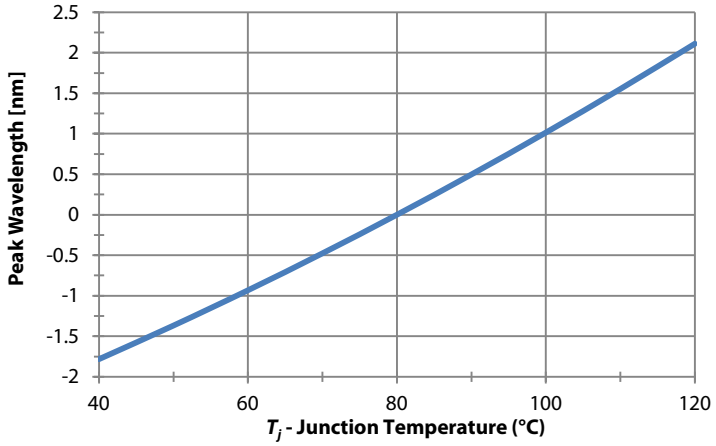
Forward Voltage *vs* T_j: Normalized to I_f = 6 A and T_j = 80°C

405 nm



Centroid Wavelength *vs* T_j: Normalized to I_f = 6 A and T_j = 80°C

405 nm



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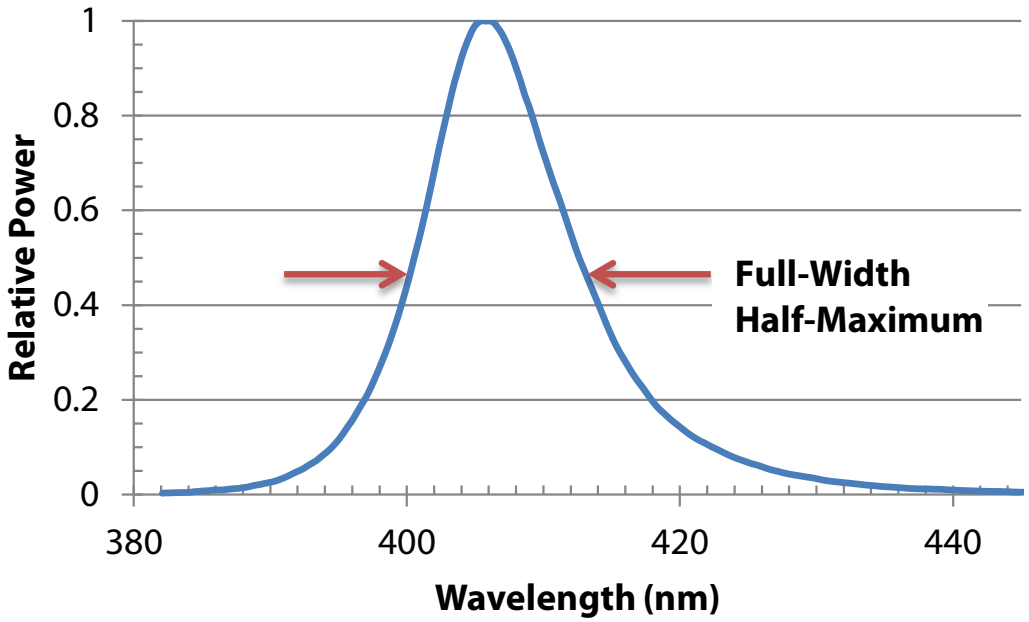
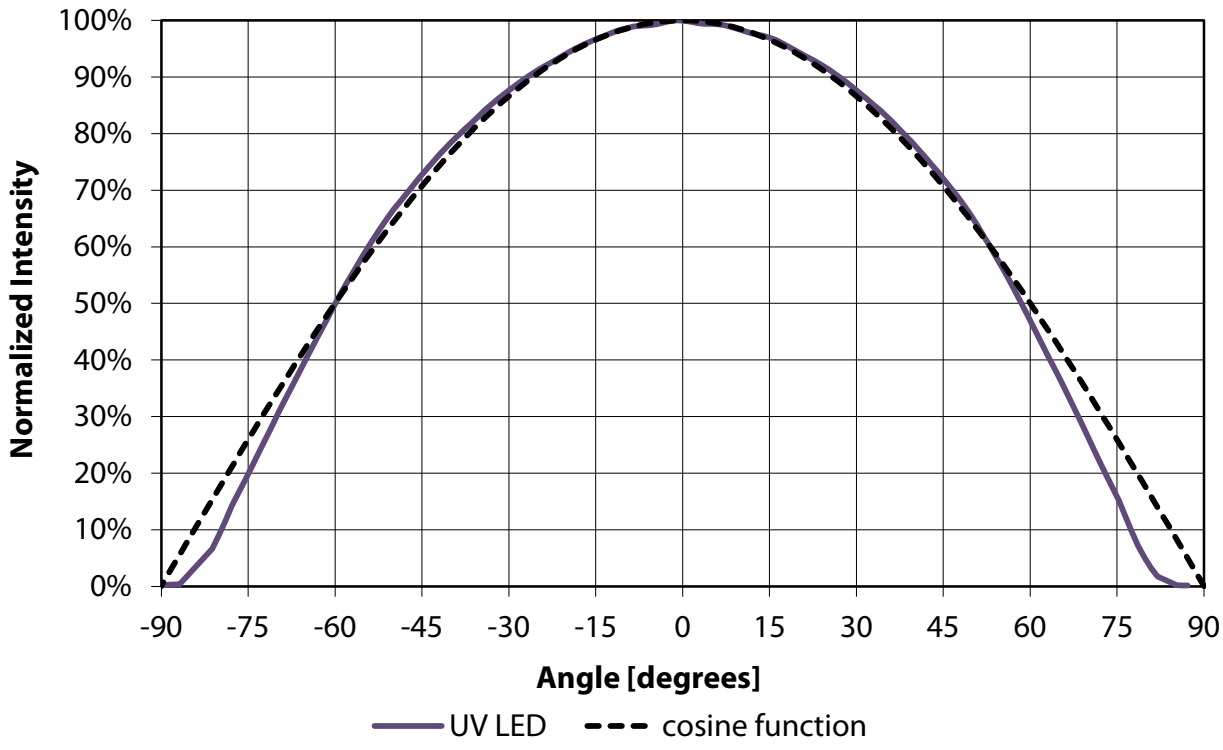
Optical Spectrum (Typical)



Angular Intensity Distribution (Typical)



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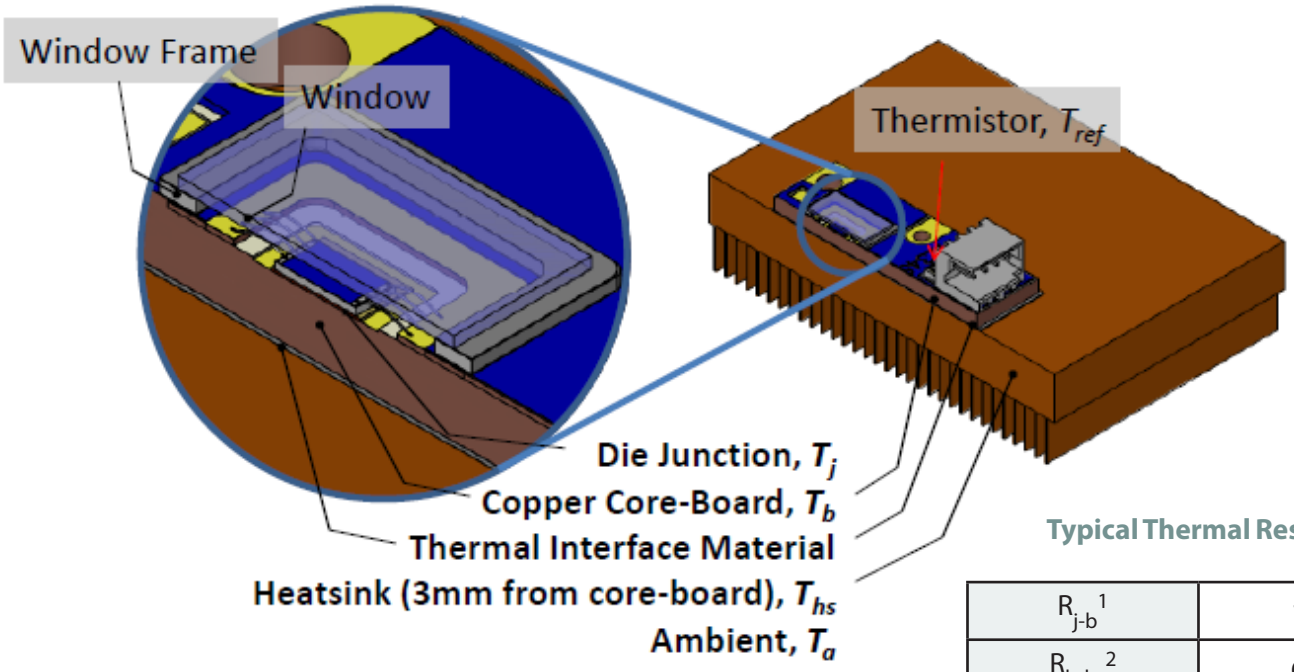
Thermal Resistance



Typical Thermal Resistance

$R_{j\text{-}b}$ [1]	1.6°C/W
$R_{b\text{-}hs}$ [2]	0.2°C/W
$R_{j\text{-}hs}$ [1,2]	1.8°C/W
$R_{j\text{-}ref}$ [2]	1.6°C/W

Note 1: Thermal resistance values are preliminary and are based on modeled results correlated to measured $R_{j\text{-}hs}$ data using the wavelength shift method. Verification of compliance with the recent releases of JEDEC Standards JESD51-14 and JESD51-5x series is pending.

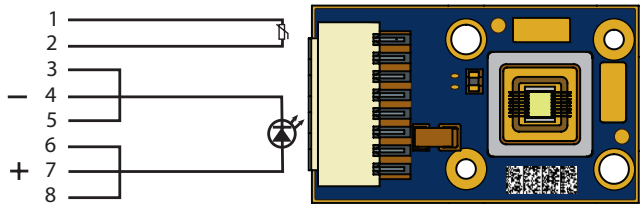
Note 2: Thermal Resistance is based on eGraf 1205 Thermal interface.

Thermistor Information

The thermistor used in CBT-39 devices are mounted on coreboards is from Murata Manufacturing Co. The global part number is NCP18XH103J03RB. Please see http://www.murata.com/ for details on calculating thermistor temperature.

For more information on use of the thermistor, please contact Luminus directly.

Electrical Pinout



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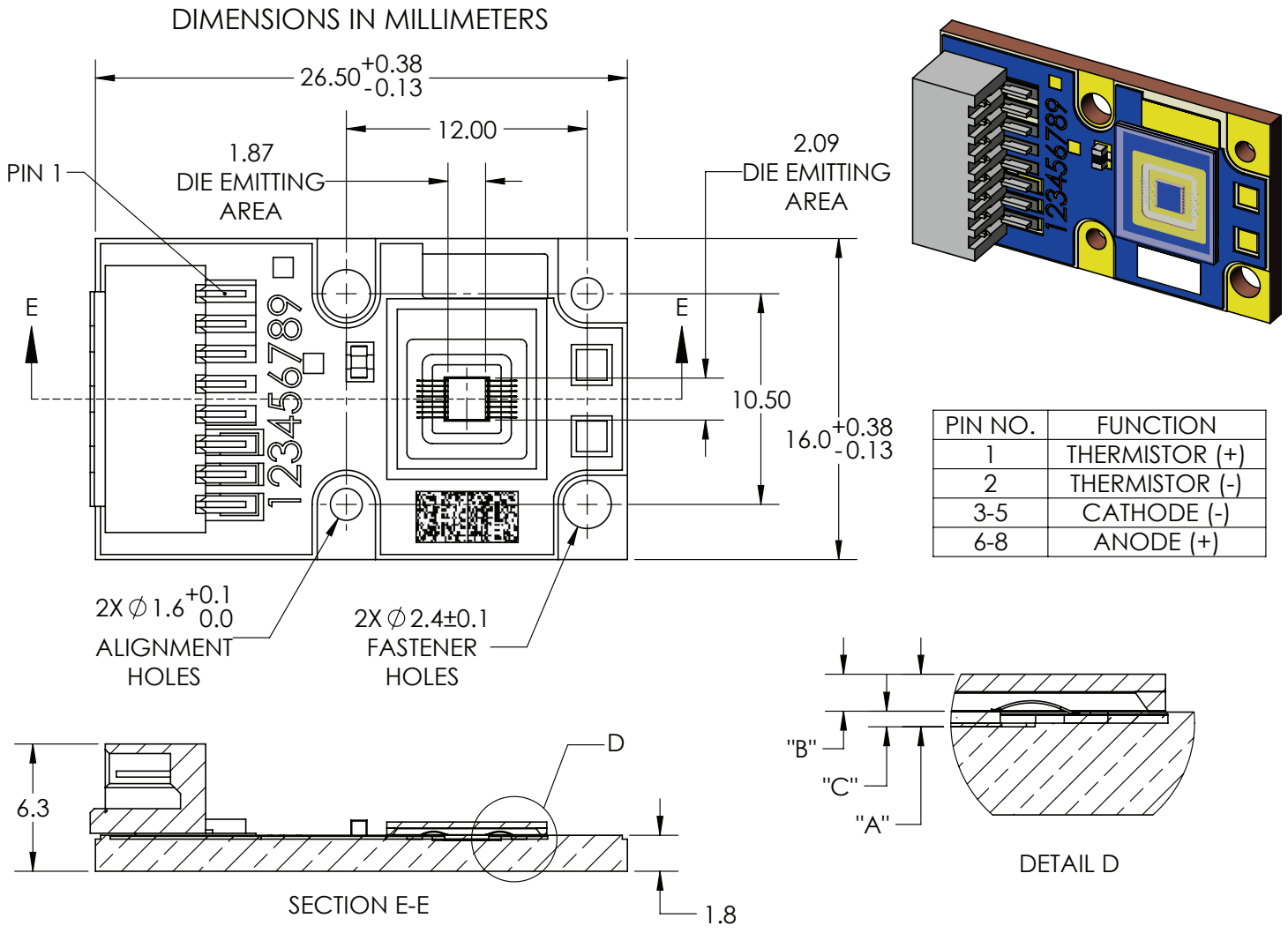
Mechanical Dimensions



PIN NO.	FUNCTION
1	THERMISTOR (+)
2	THERMISTOR (-)
3-5	CATHODE (-)
6-8	ANODE (+)

DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO TOP OF WINDOW	0.92	±0.13
"B"	TOP OF DIE EMITTING AREA TO TOP OF WINDOW	0.64	±0.11
"C"	TOP OF METAL SUBSTRATE TO TOP OF DIE EMITTING AREA	0.27	±0.02

DWG-002071

- Connector- MOLEX Part Number: 874380843 or Global Part Number: WTB16-081SF. Please refer to DWG-001703 (separate document) for pin-out information

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Ordering Information

Ordering Part Number	Color	Description
CBT-39-UV-C32-DA400-22	UV	CBT-39 -UV consisting of a 3.9 mm^2 LED, with a minimum power of 4W, a wavelength range from 400nm to 410nm, a thermistor, a connector, a window and a copper-core PCB.

Note 1: For information on ordering specific bins or bin ranges please refer to the CBT-39-UV Binning and Labeling document PDS-002170.

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